

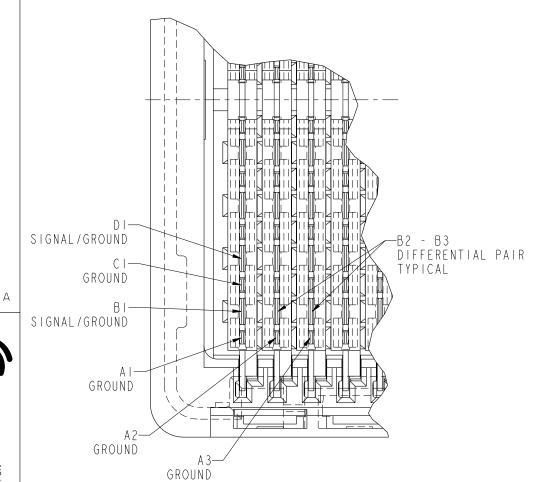
REV E - 2006-04-18

PDM: Rev:F

STATUS Released

Printed: Jul 21, 2007

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NOTES:

(I) MATERIAL:

HOUSING: LCP CONTACT: COPPER ALLOY PLATING (CONTACT): Au OVER Ni.

UL RATING: 94 V-O

SOLDER BALL: (SEE TABLE) EUTECTIC SnPb OR LEADFREE 95.5 Sn/4Ag/0.5Cu

- (2) SOLDER BALLS WILL NOT BE PERFECT SHPERICAL SHAPE DUE TO REFLOW ATTACHMENT.
- MATED HEIGHT EFFECTED BY CUSTOMERS' PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE & SOLDER PASTE.
- CONTACTS IN ROWS A,C,E,G,J,K,M,P,R AND T ARE SINGLE BEAM CONTACTS, TYPICALLY USED AS GROUND PINS. (NOTE: CONTACTS IN ROWS J & K ARE TIED TOGETHER [COMMONED])
- CONTACTS IN ROWS B, D, F, H, L, N, Q AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.

PLUG INTERFACE **DESCRIPTION**

SCALE 7:1

 $1 \mid 2$

mat'l code			SEE NOTE I			tolerances unless otherwise specified					СП	STOM	ER		F	Ci					
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						angles	0.		±0.(+2°)50	-) +	:1	 15m	m PL	.UG /	4SSY	. 29	6 SI	G. P	OS.
						dr	D. WA			5/01	1	MM		_	ct fam			G-Ar		code	
						engr	D. J01	HNESCU	1/9	9/01	-	IVIIVI	-	size	dwg	no				2	13
						chr	D. 11	NGRAM	5/4	1/01	scale			_ \		5	57(\cap		she	et
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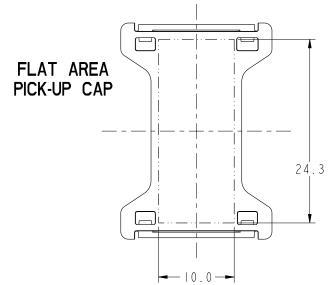
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-PLUG ASSY -PCB P/N 55700 DIM. "A" REF. MATED HEIGHT AFTER REFLOW SEE NOTE 3. -RECPT. ASSY. (SEE TABLE)

END VIEW OF MATED CONNECTORS

DIM. "A"	RECPT. ASSY. P/N
20	55701
30	55733

Α

NOTES CONTINUED

SPECIFIED POSITIONAL TOLERANCE DEFINES PAD TO PAD LOCATION WITHIN LAND PATTERN. POSITIONAL TOLERANCE OF LAND PATTERN TO FUDICIAL MARKS OR PCB DATUMS SHALL BE DEFINED BY CUSTOMER. FOR RECOMMENDED PRODUCT APPLICATION AND PCB DESIGN DETAILS, SEE DOC. NO. GS-20-016.

7)FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033 LEADFREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE, LEADFREE PRODUCT IS THERFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION.

(8) THIS PRODUCT MEETS THE EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008. PRODUCT MEETING WITH THES DIRECTIVE IS

IDENTIFIED IN THE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSITION.

tolerances unless FÇj SEE NOTE I CUSTOMER otherwise specified ecn no. dr date $0.X \pm 0.3$ www.fciconnect.com projection linear $0.XX \pm 0.10$ GIG-Array $0.XXX \pm 0.050$ 15mm PLUG ASSY, 296 SIG, POS. $\pm 2^{\circ}$ GIG-Array code dr D. WAUGHEN 3/6/01 MM product family engr D. JOHNESCU 1/9/01 size dwg no D. INGRAM sheet 5/4/01 55700 4 appd D. JOHNESCU 5/4/01 sheet revision sheet cage code 22526 4 Pro/E

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